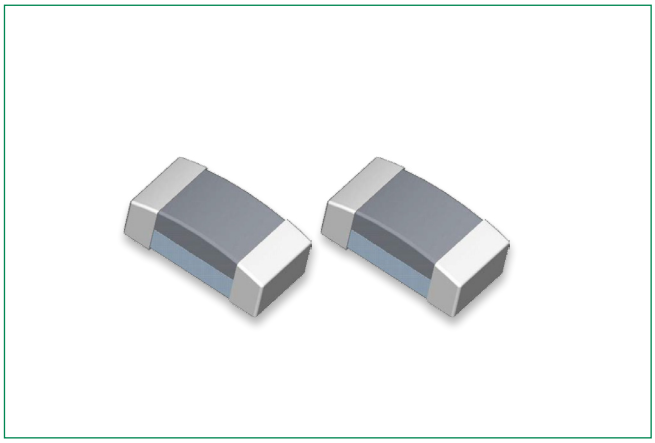
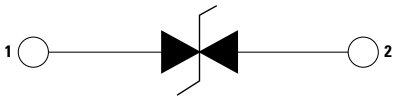
PGB2 0201 Series

Surface Mount Polymeric Electrostatic Discharge Suppressors



Equivalent Circuits



Product Characteristics

Part Number	Lines Protected	Component Package
PGB2010201KR	1	0201

Description

PULSE-GUARD® ESD Suppressors help protect sensitive electronic equipment against electrostatic discharge (ESD).

They use polymer composite materials to suppress fast- rising ESD transients (as specified in IEC 61000-4-2), while adding virtually no capacitance to the circuit.

They supplement the on-chip protection of integrated circuitry and are best suited for low-voltage, high-speed applications where low capacitance is important to ensure minimal interference of data signal integrity.

The new and ultra-small surface mount PGB2 0201 products offer a RoHS Compliant, Halogen Free, and 100% Lead Free circuit protection solution.

Features & Benefits

- Lead-free, Halogen-free, and RoHS compliant
- Ultra-low capacitance
- Low leakage current
- Fast response time
- One line of protection
- Bi-directional
- Withstands multiple ESD strikes
- Compatible with pick-and-place processes

Applications

- Antenna circuit
- Laptop / desktop computer
- Network hardware
- HDMI 1.3 / 1.4 / 2.0
- USB 3.2
- Computer peripherals
- Digital camera
- External storage
- Set-top box
- SATA and eSATA

Electrical Characteristics

Items	PGB 0201					Unit
Rated voltage (Max)	**6**	**12**	**15**	**24**	**30**	**V**
Leakage current			0.01			µA
Trigger voltage			300			V
Clamping voltage			20			V
Capacitance @1MHz			0.05			pF
IEC 61000-4-2 Direct Discharge			8			kV
IEC 61000-4-2 Air Discharge			15			kV
Response time (Max)			1			ns
ESD withstand pulses			1000			pulses

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Environmental Specifications

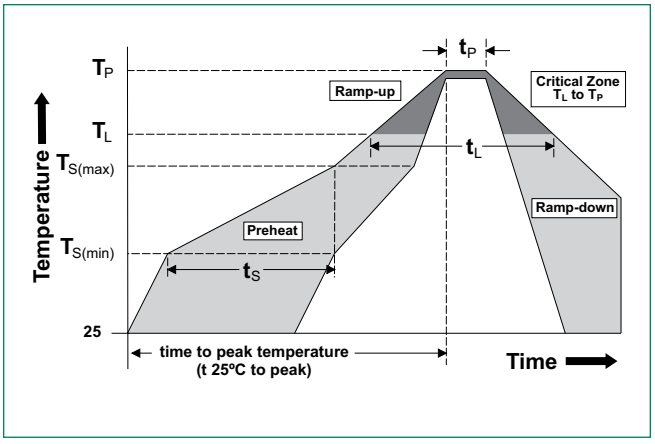
Item	Test Condition	Reference
Operating Temperature	-40 °C to 85 °C	
Bias Humidity	Rated voltage ,90%RH, 40 °C, 1000 hrs	MIL-STD-202 Method 103
Thermal Shock	-40 °C to 85 °C, 30 min. cycle, 5 cycles	JIS C 0025 (1998) Test Na
High Temperature Load Voltage	Rated voltage, 85 °C 1000 hrs	MIL-STD-202G Method 108
Solder Leach Resistance	260 °C 10s	MIL-STD-202G Method 210F

Part Number List

Part Number	Rated Voltage (Max)
PGB2010201KR-06NR	6 V
PGB2010201KR-12NR	12 V
PGB2010201KR-15NR	15 V
PGB2010201KR-24NR	24 V
PGB2010201KR-30NR	30 V

Soldering Parameters

Reflow Condition		Pb-free assembly
Pre Heat	**- Temperature Min ($T_{s(min)}$)**	150 °C
	- Temperature Max ($T_{s(max)}$)	200 °C
	- Time (Min to Max) (t_s)	60–180 seconds
Average Ramp-up Rate (Liquidus Temp (T_L) to peak)		5 °C / second max.
$T_{S(max)}$ to T_L - Ramp-up Rate		5 °C / second max.
Reflow	**- Temperature (T_L) (Liquidus)**	217 °C
	- Temperature (t_L)	60–150 seconds
Peak Temperature (T_P)		$250^{+0/-5}$ °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5 °C / second max.
Time 25°C to peak Temperature (T_P)		8 minutes max.



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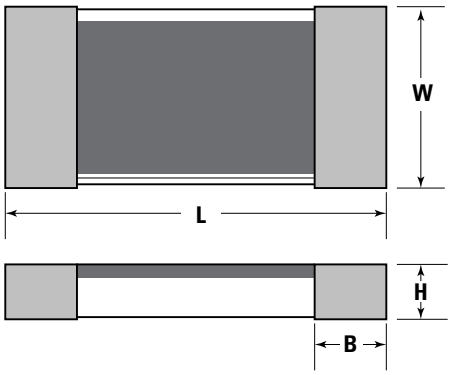
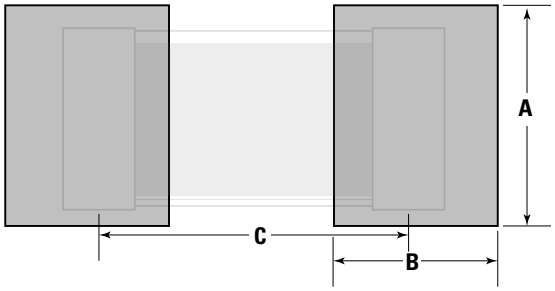
Dimensions

Unit: mm



Chip Size	L	W	H	B
0201	0.62±0.05	0.32±0.03	0.3±0.05	0.165±0.05

Recommended Landing Pad



Marking	Unit (mm)
A	0.35±0.05
B	0.27±0.05
C	0.5±0.05

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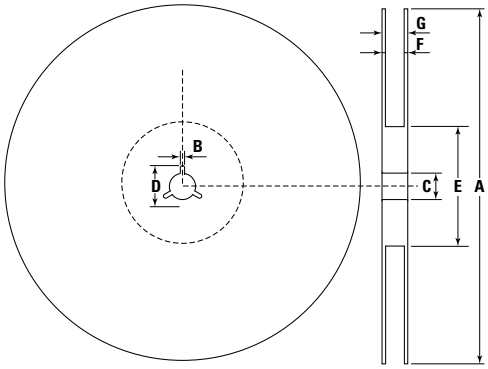
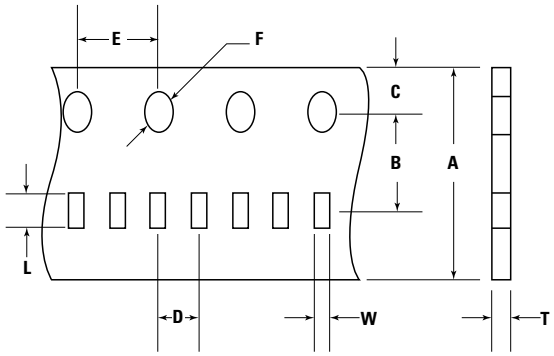
Packaging, Tape and Reel Specifications





Marking	Unit (mm)
A	178.0±2.0
B	2.0±0.5
C	13.0±0.5
D	21.0±0.8
E	62.0±1.5
F	9.0±0.5
G	13.0±1.0

Marking	Unit (mm)
A	8.00±0.30
B	3.50±0.05
C	1.75±0.05
D	2.00±0.05
E	4.00±0.10
F	1.55±0.05
L	0.68±0.02
W	0.37±0.02
T	0.42±0.02

Part Number	Packaging Code	Quantity	Packaging Option	Packaging Specification
PGB2010201	KR	15000	Tape and Reel (7" reel)	Carrier Tape: 8 mm, paper Reel: 7" (178 mm) reel

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